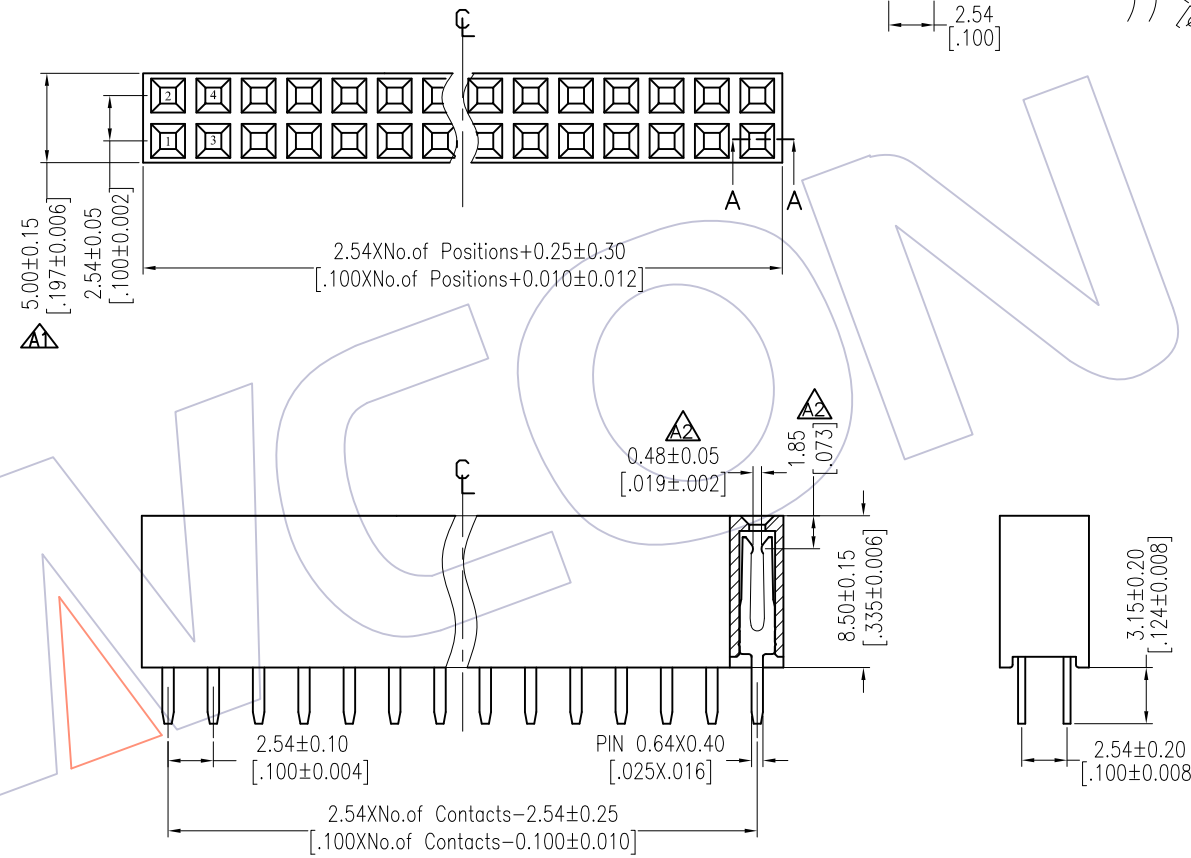
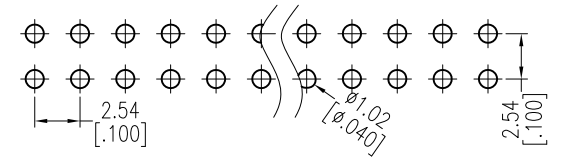


HSF

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

NOTES:
 Current Rating: 3.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 1000V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze or Brass
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0(Std)
 Or PBT+30%G.F UL94V-0



Ordering Information

2185 - 2 XX S XX X Y N A 1

No. of Pins per ROW: 02-40PIN
 Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Matte Tin
 Insulator:
 A=PBT
 C=PA9T
 Packing:
 T=Tube
 A=Tray

Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		

SECTION: A-A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE:	Customer NO.	WCON-Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com	WCON-Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: salesks@wcon.com
A2	2016/08/23	ADD THE DIM.	△2	x.x ±0.40	Surong Xu	2016/08/23	UNIT mm		2185-2XXSXXXYN A1				
A1	2014/05/29	Modify Drawing 6.00 → 5.00	△1	x.xx ±0.25	CHECK	DATE	SIZE A4						
A0	2012/08/15	NEW	-----	x.xxx ±0.15	APPROVE	DATE	SHEET 1/1						
				Angle ± 3'			PROJ.						
				DIM TOL									

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